



Exceptional service in the national interest

# Relating Photovoltaic Module Stresses to Encapsulant Thermomechanics

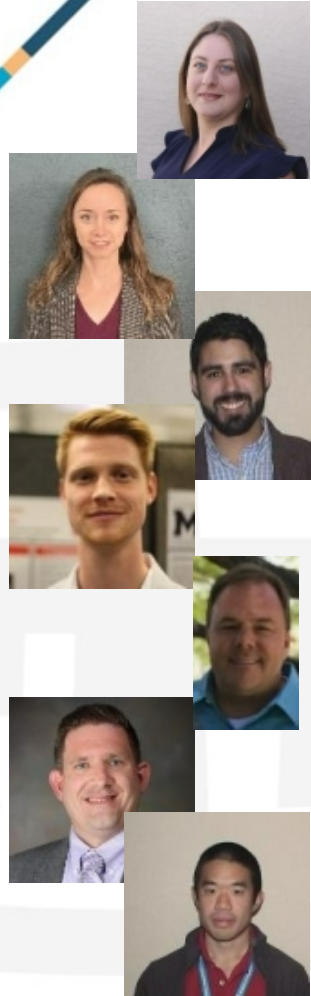
Christine C. Roberts, Ashley M. Maes,  
Anthony McMaster, Matthew Phillips,  
Charles Robinson, Scott A. Roberts, James Y. Hartley

ccrober@sandia.gov

October 12, 2021

Society of Rheology Annual Meeting

Virtual Session





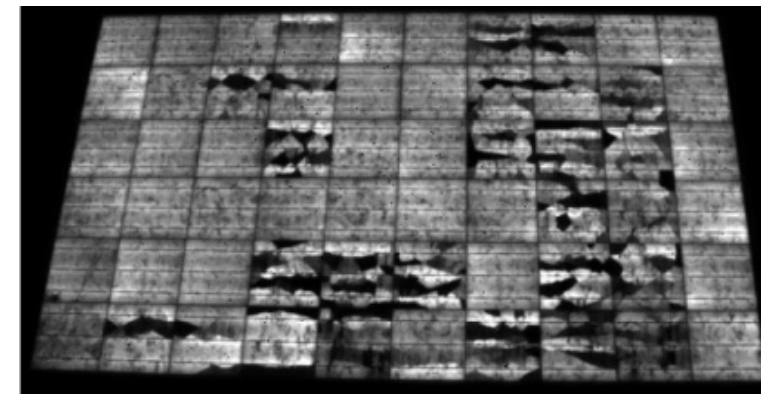
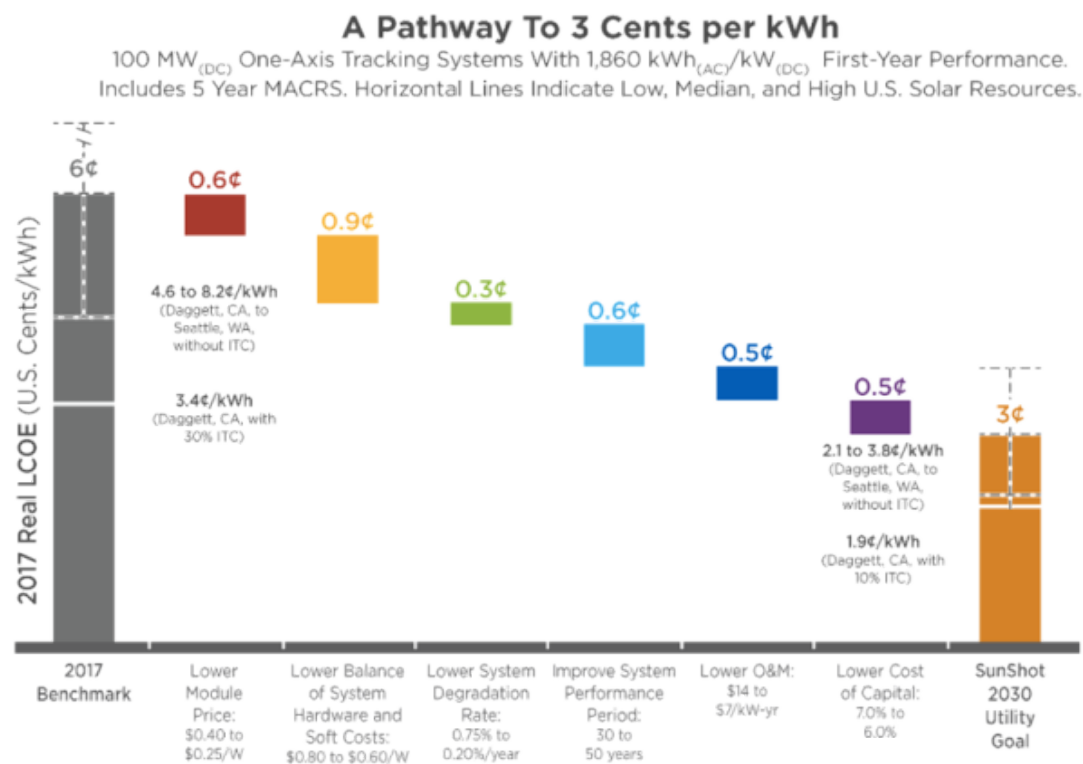
# PHOTOVOLTAIC MODULE DURABILITY

## Biden administration memo September 2021:

Solar power can be 45% of nation's energy by 2035

## PV Module Economics:

- Industry driven by \$/W where ~1/2 cost is in packaging
- Goal: 3¢ / kWh by 2030
- Typical warranty: 80% power after 25 years



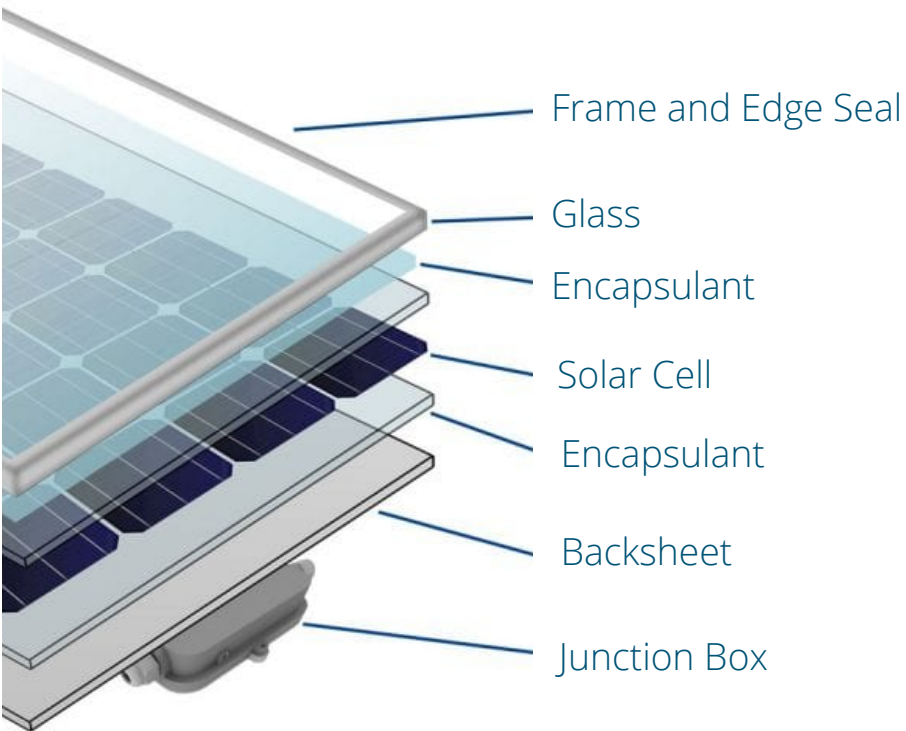
Electroluminescence image of a PV module shows cell damage  
Guada, 2020 Energy Science and Engineering



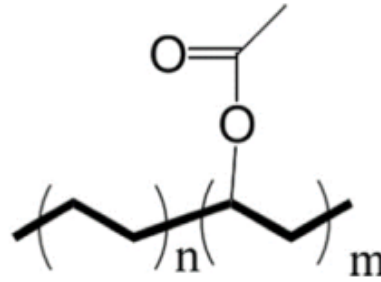
Animals are used to control weeds around PV installations  
<https://www.youtube.com/watch?v=R0F7JYAr8IU>



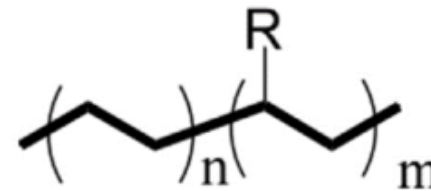
# POLYMERS PROTECT PV MODULES



Layers of a typical silicon PV module



EVA (Ethylene Vinyl Acetate)  
~30% vinyl acetate  
Crosslinked - peroxides



R = -CH<sub>3</sub>, -(CH<sub>2</sub>)<sub>n</sub>CH<sub>3</sub>, others

POE (Polyolefin)

Encapsulants



Laminated under heat, vacuum

New design concepts: glass-glass, frameless, thin-film, bifacial, glassless  
Reduce \$/W through advances in packaging



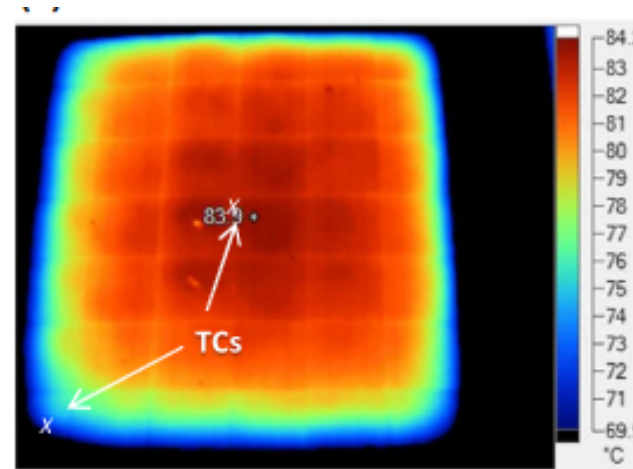


# FAILURES OCCUR IN PACKAGING

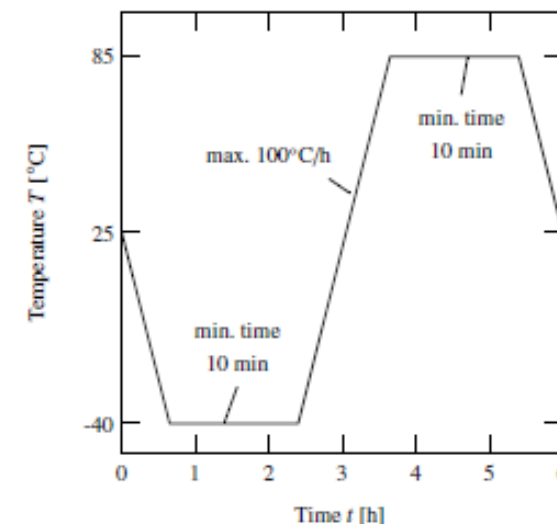
Polymers provide adhesion between layers, protection from water, and electrical isolation

Transparency critical for function

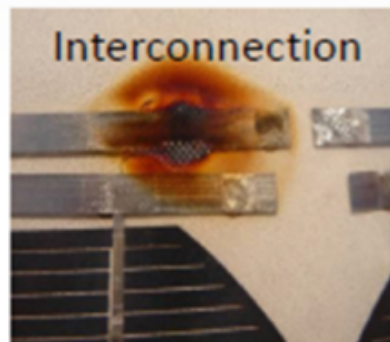
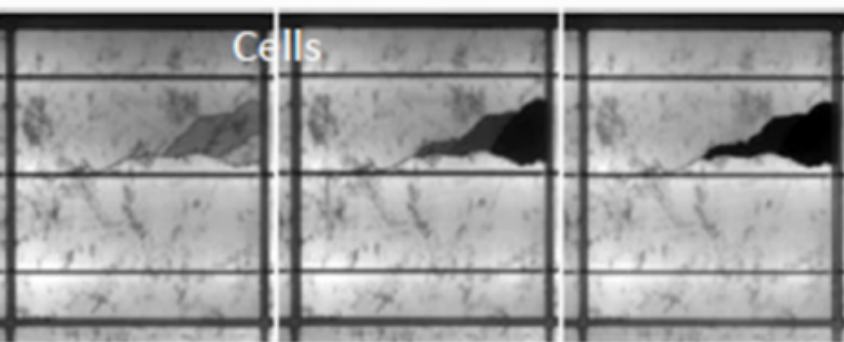
Stressors: Water, Wind loads, Temperature, Electric Fields, Animals, UV aging...



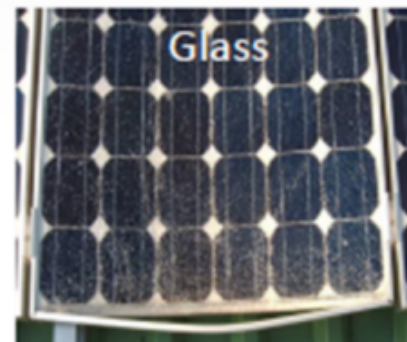
IR measurements of modules installed in Arizona show internal T's can reach >90C  
Kempe *et al.* 2015



**Fig. 29.2** One cycle of the temperature cycling test according to IEC 61215  
Eitner, 2011



David DeGraff



John Wohlgemuth



DuPont

DOE DuraMAT consortium established between NREL, SNL, LBNL, SLAC, others

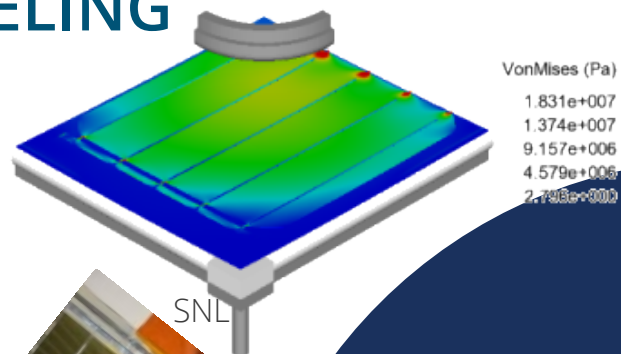




# ACCELERATE DESIGN CYCLES THROUGH COMPUTATIONAL MODELING



NREL

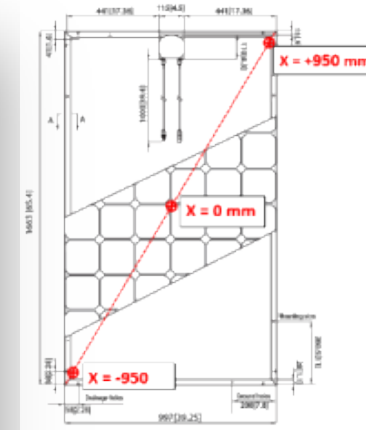


Validate

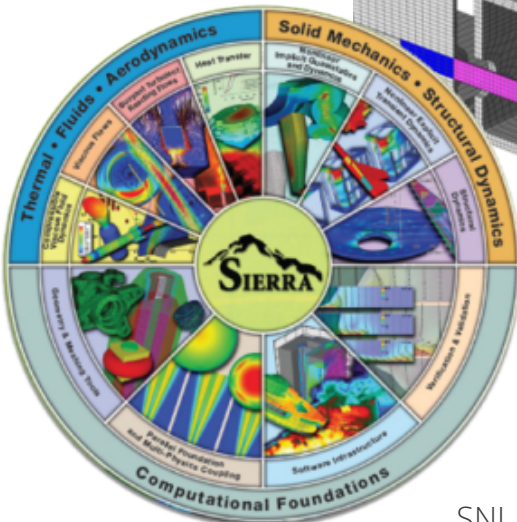
Design

Computational Model

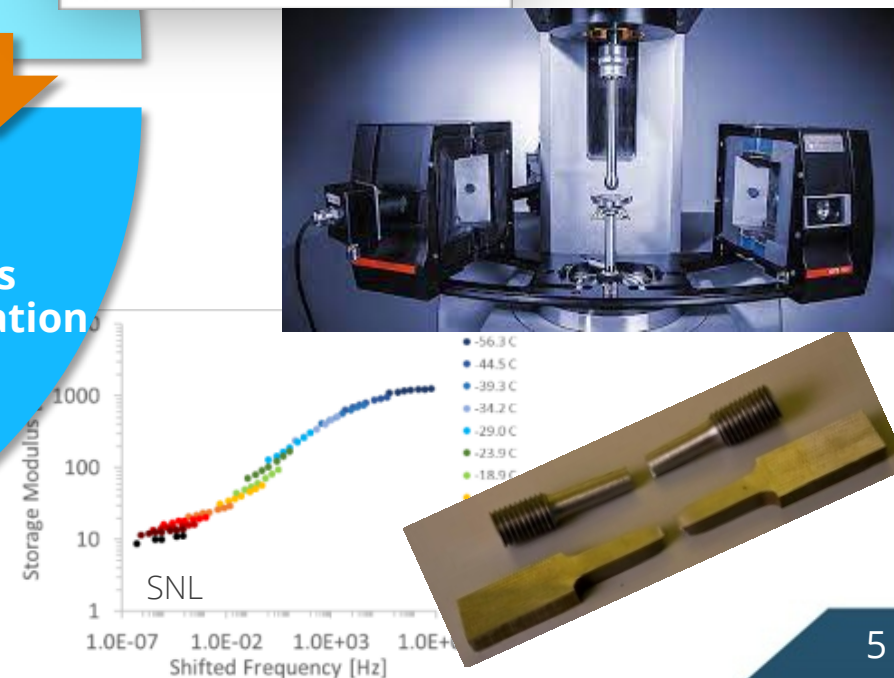
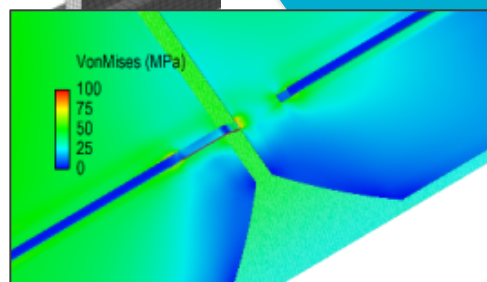
Materials Characterization



SOLARTECH UNIVERSAL



SNL

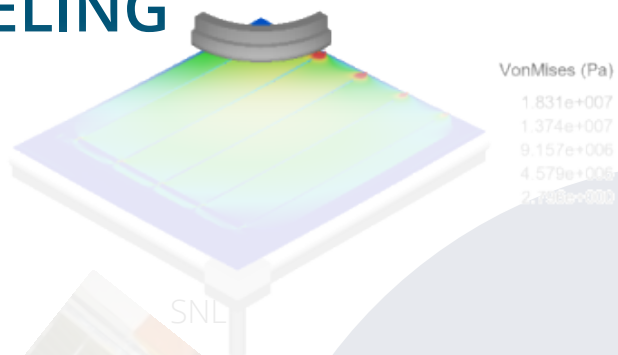




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NREL



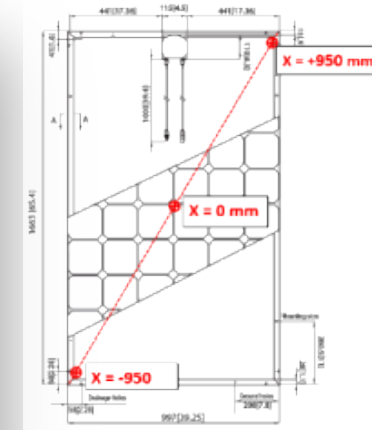
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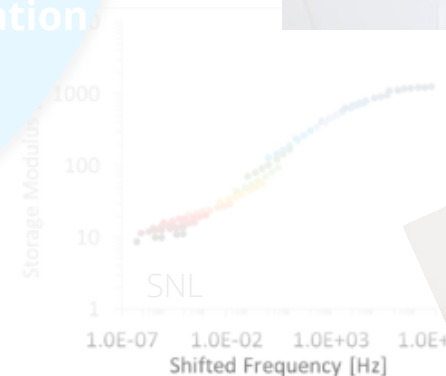
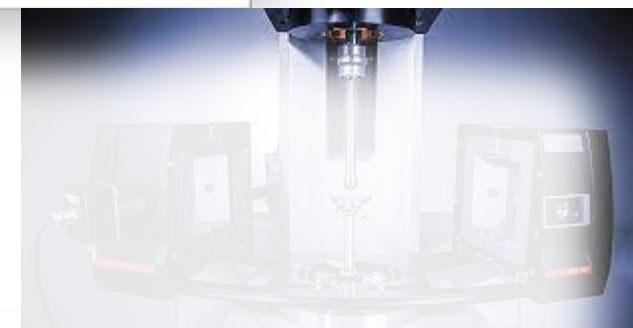
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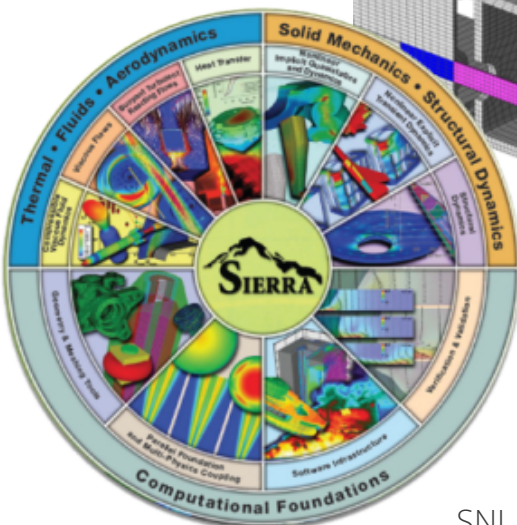
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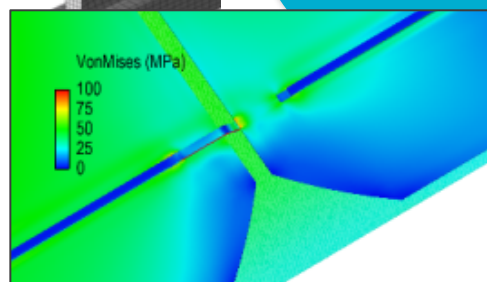
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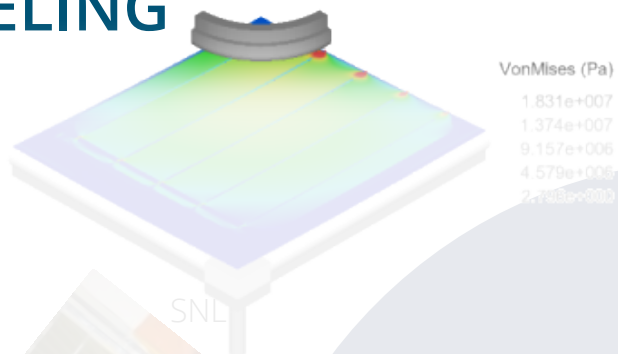




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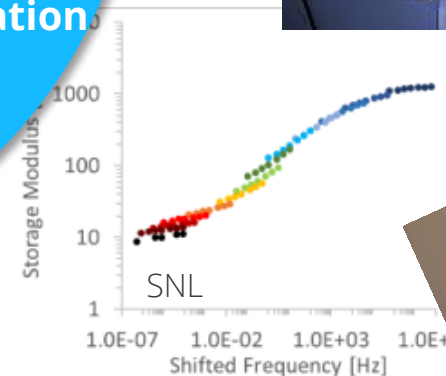
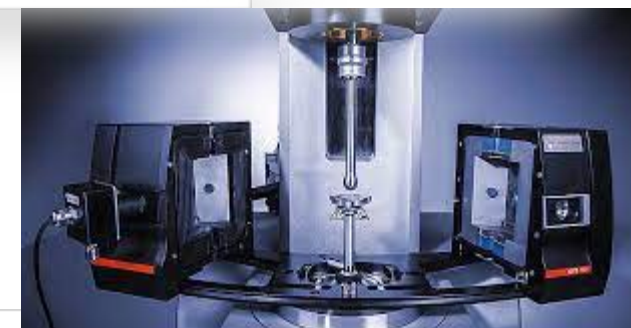
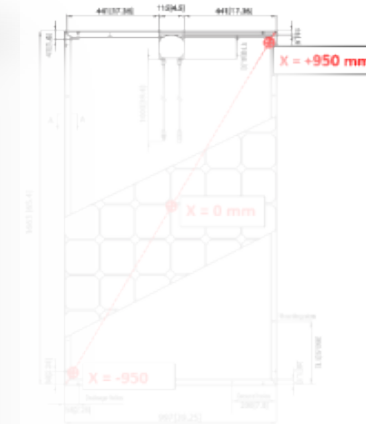
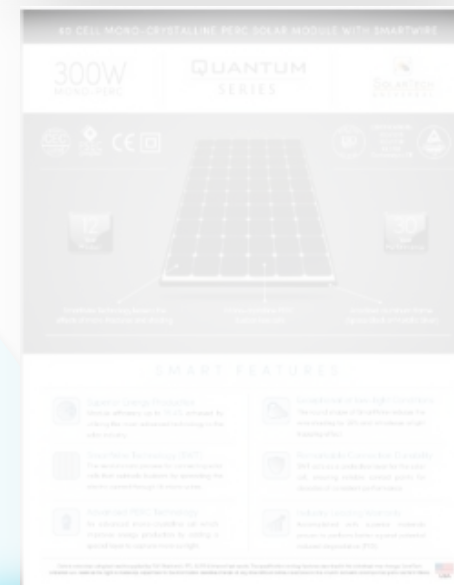
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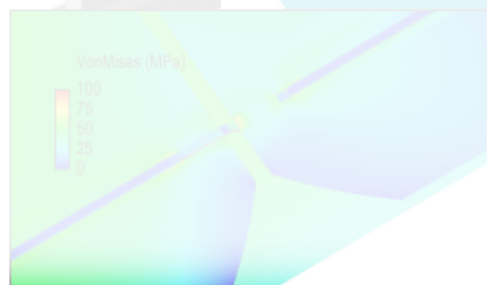
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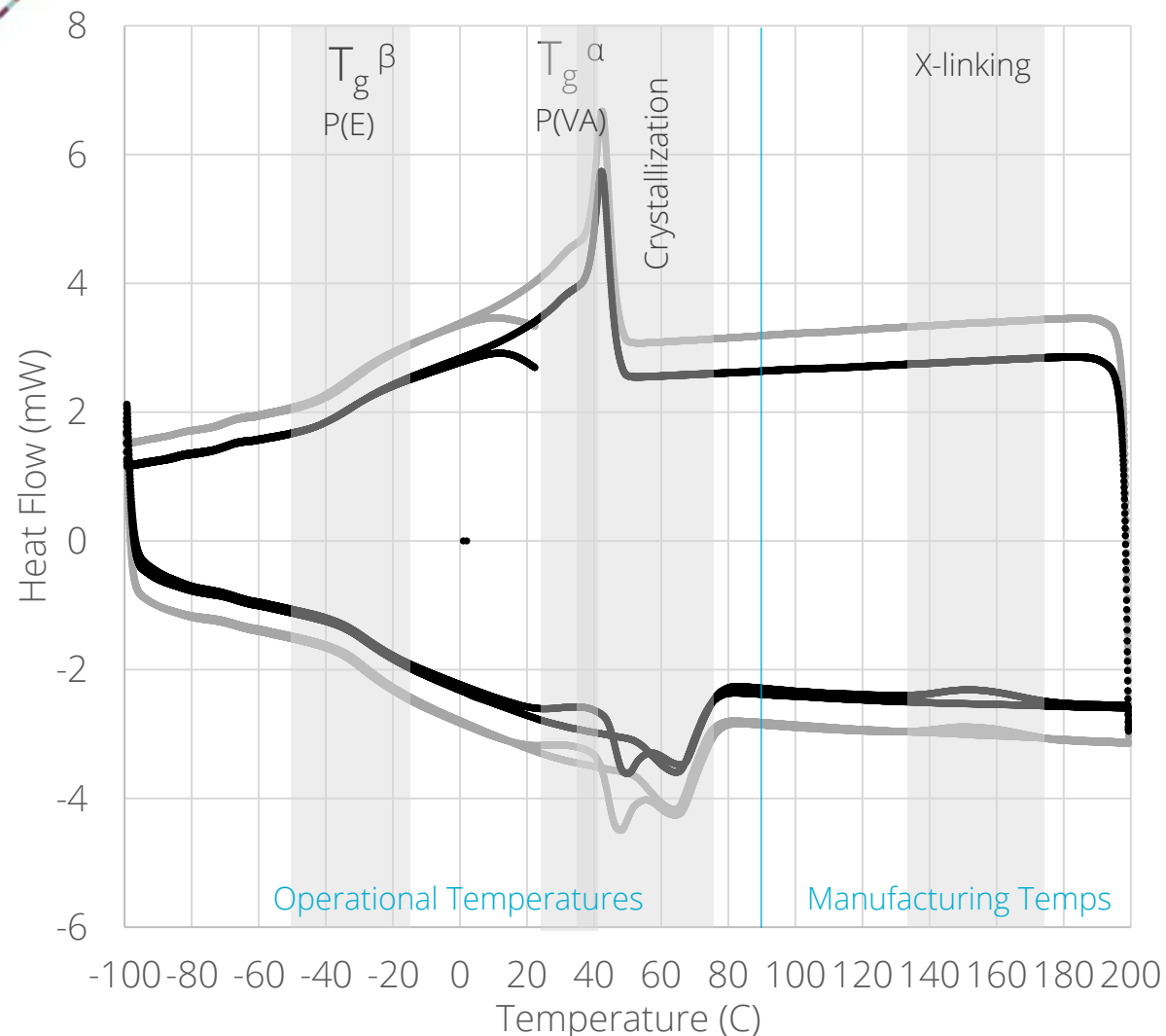




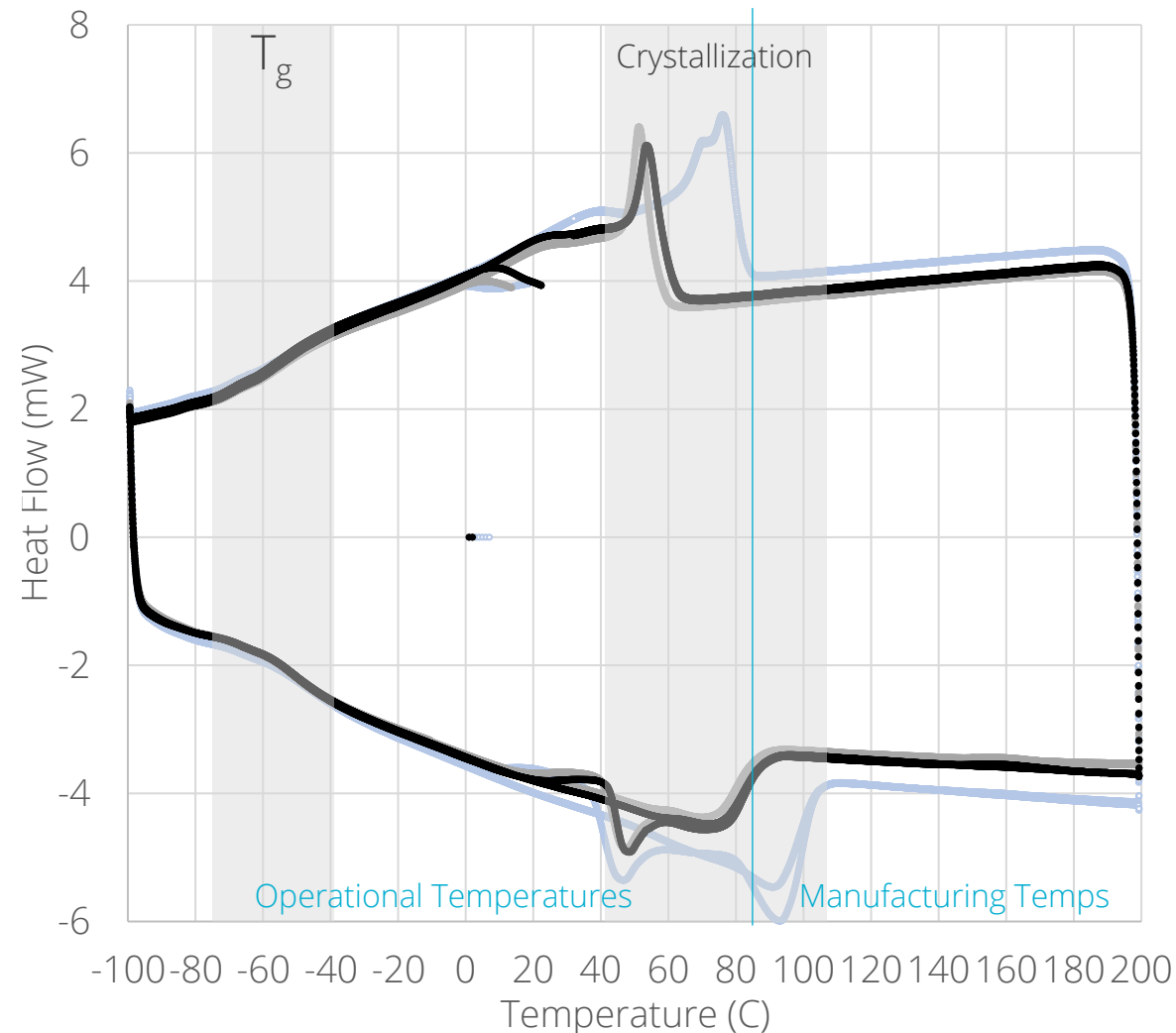


# THERMAL TRANSITIONS IN ENCAPSULANTS

Laminated EVA's



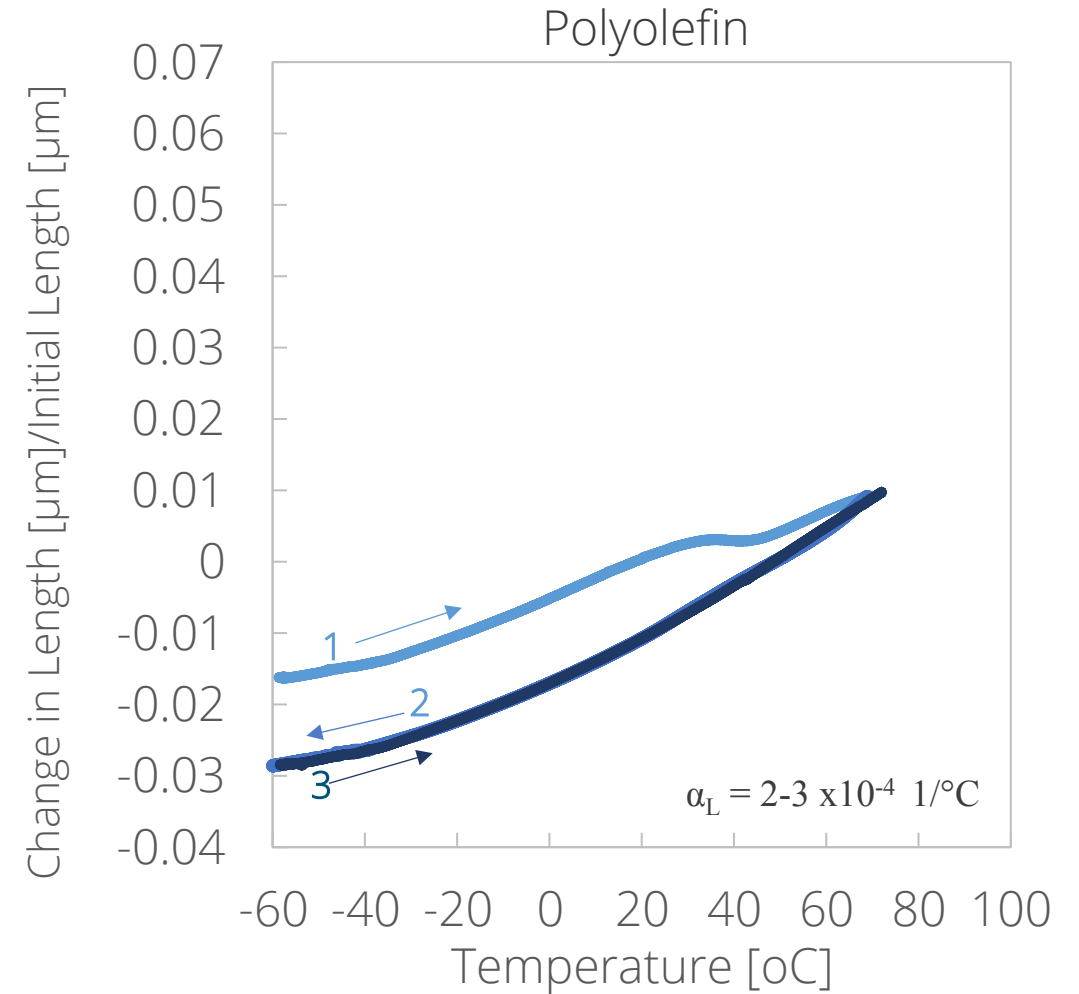
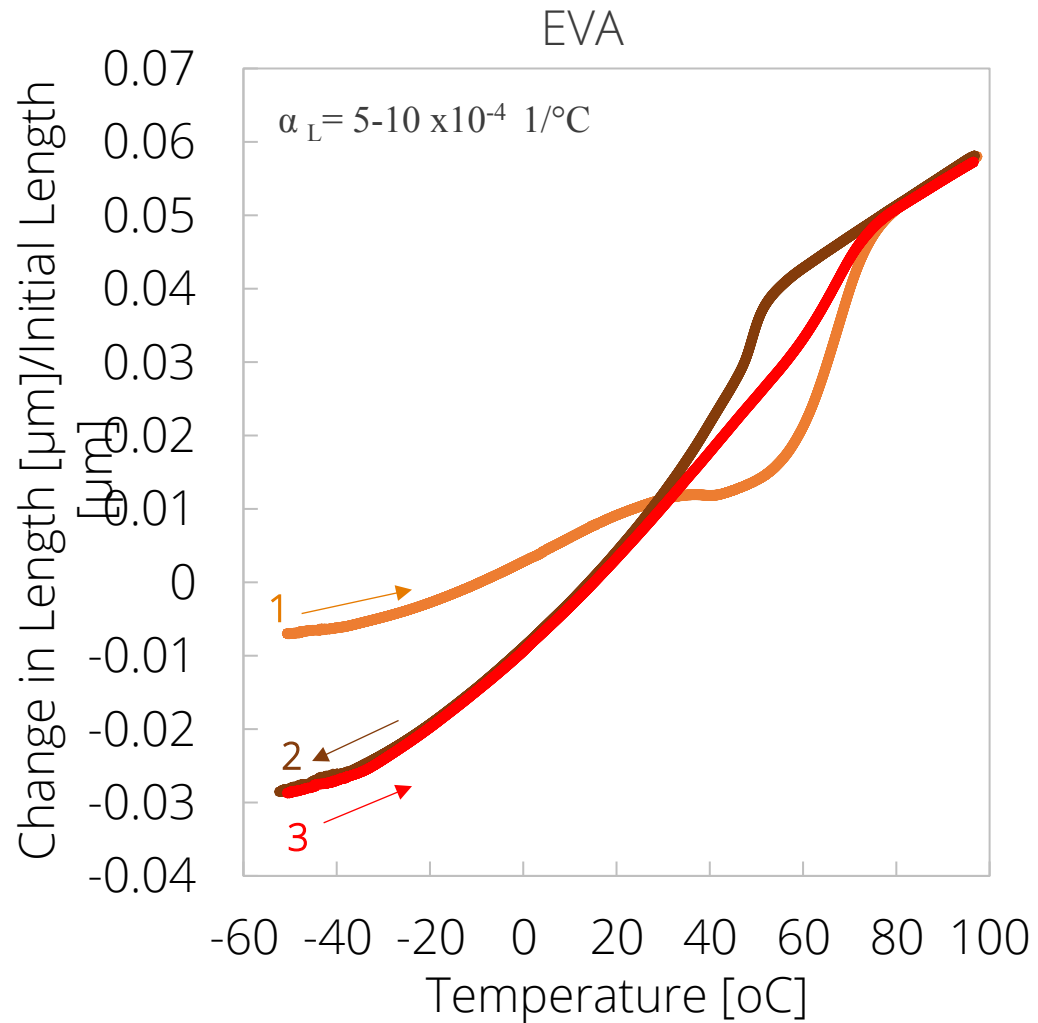
Laminated POE's



DSC data show key polymeric transitions in PV day/night cycles

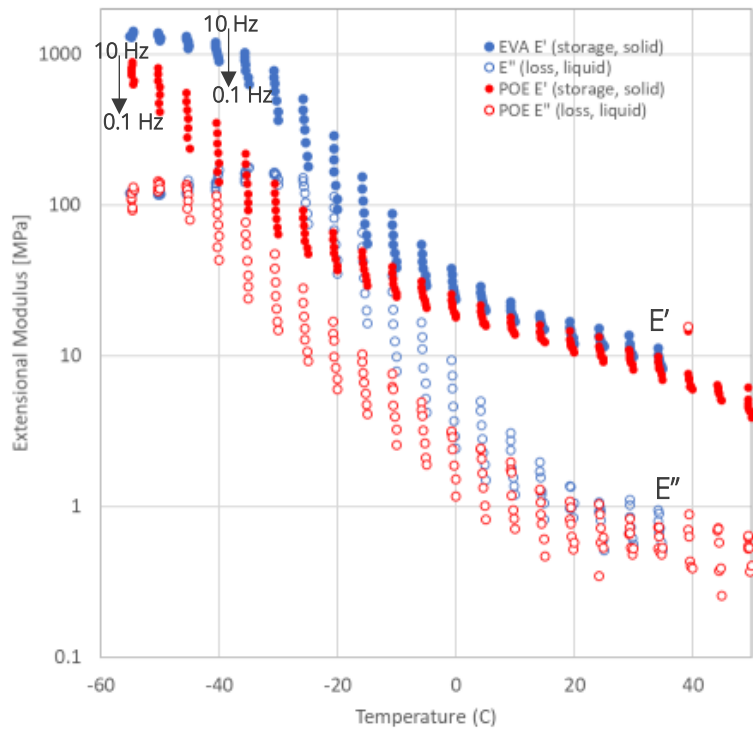


# THERMAL EXPANSION COMPLICATED BY CRYSTALLIZATION

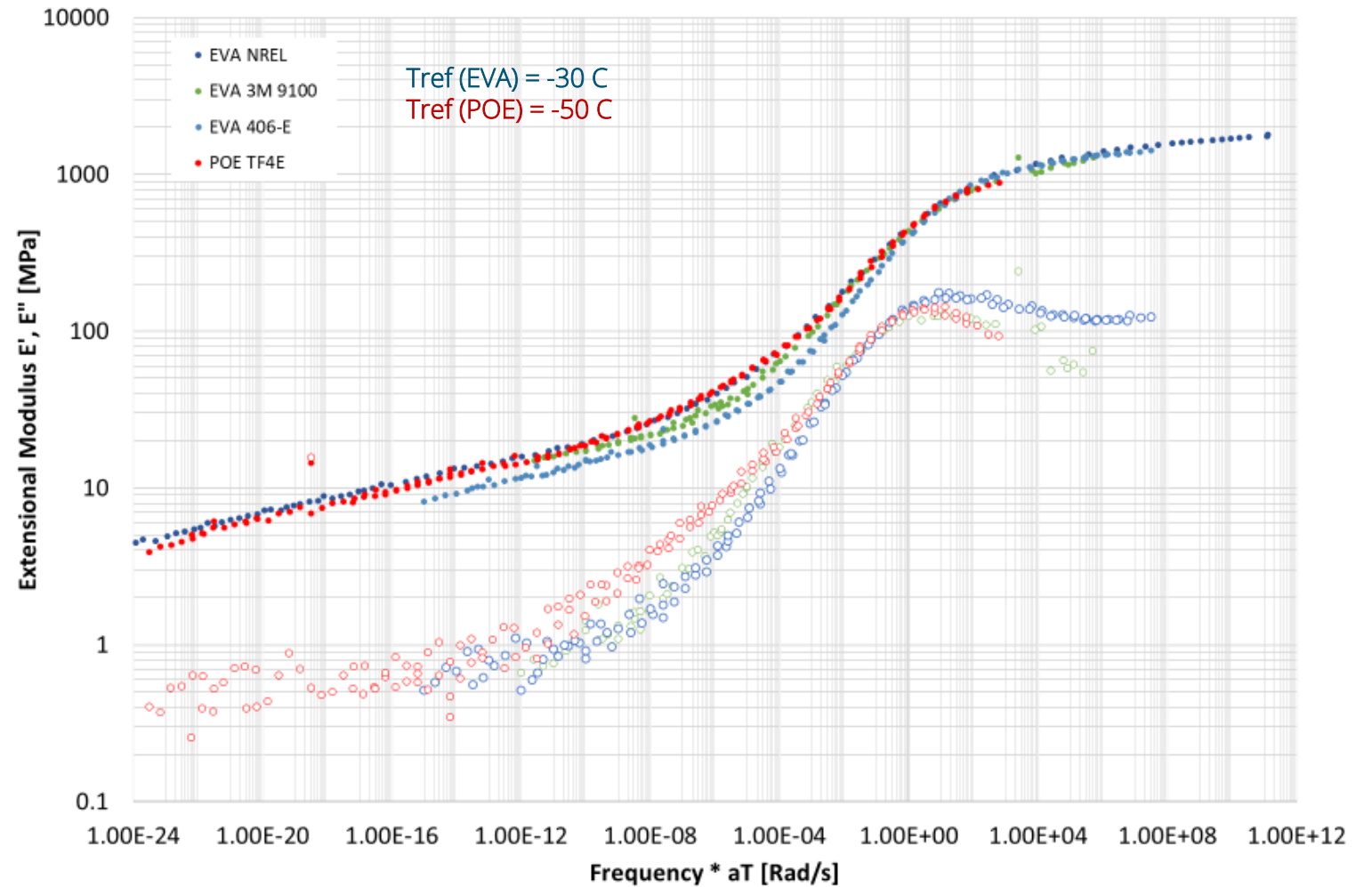




# MODULUS OF ENCAPSULANTS



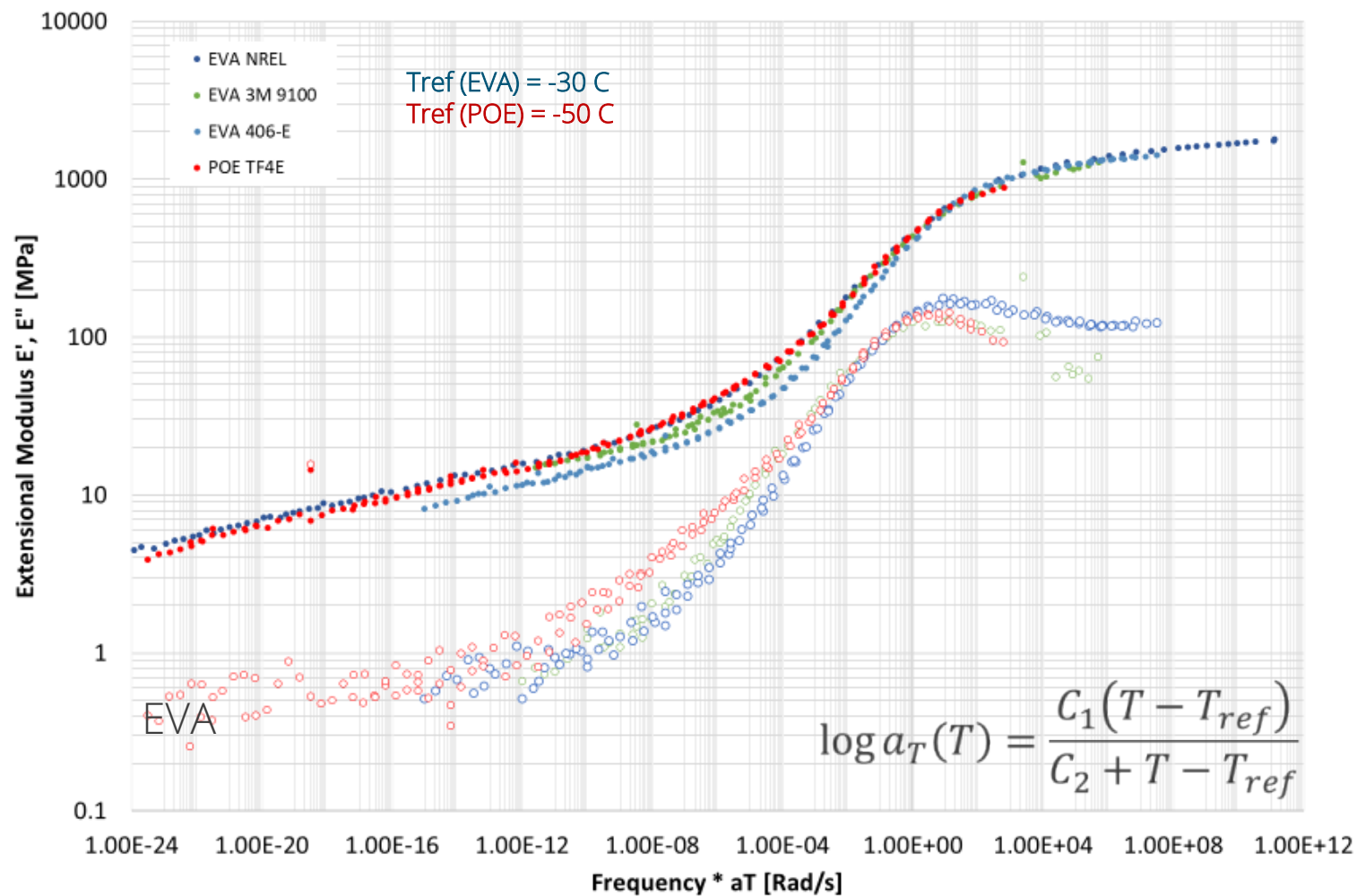
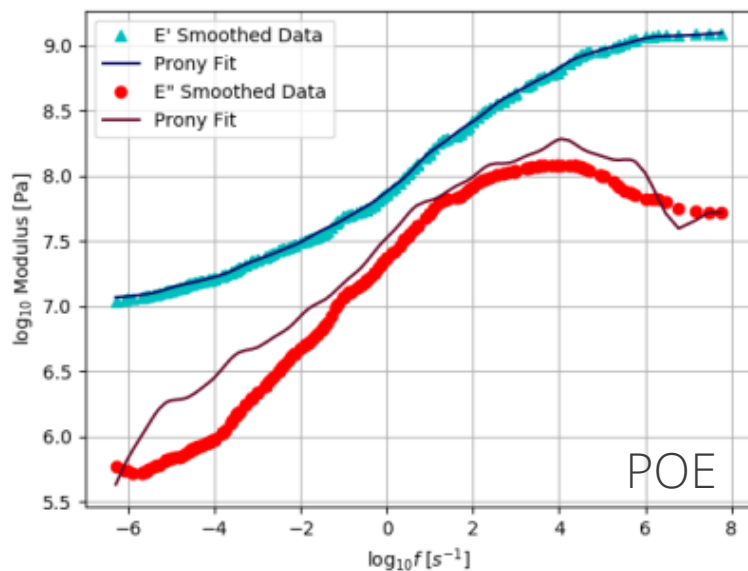
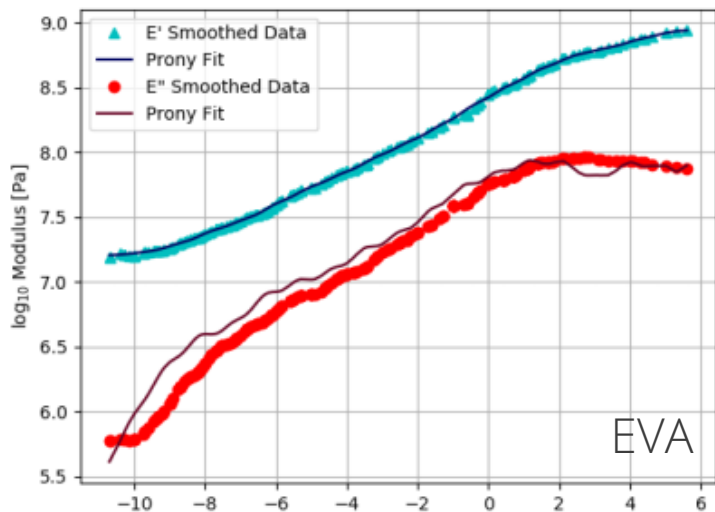
Isothermal frequency sweeps 10 Hz – 0.1 Hz  
Netzsch DMA in extension







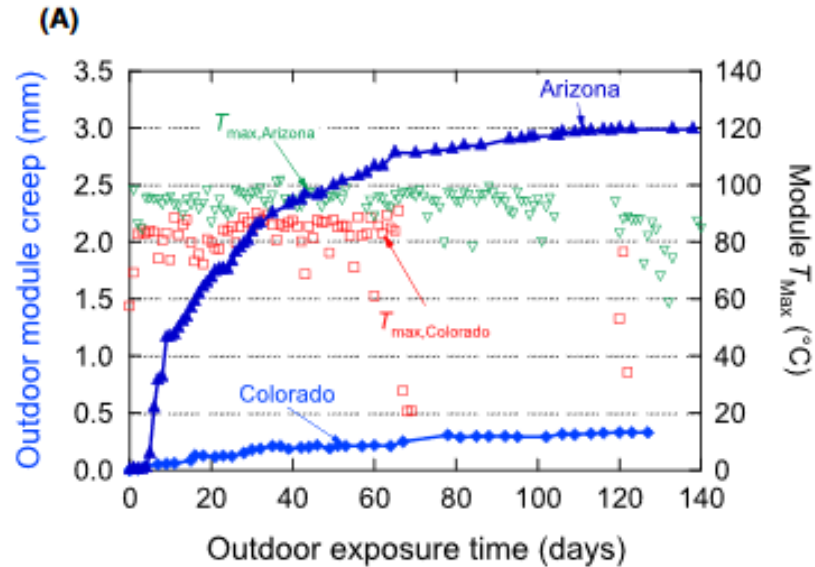
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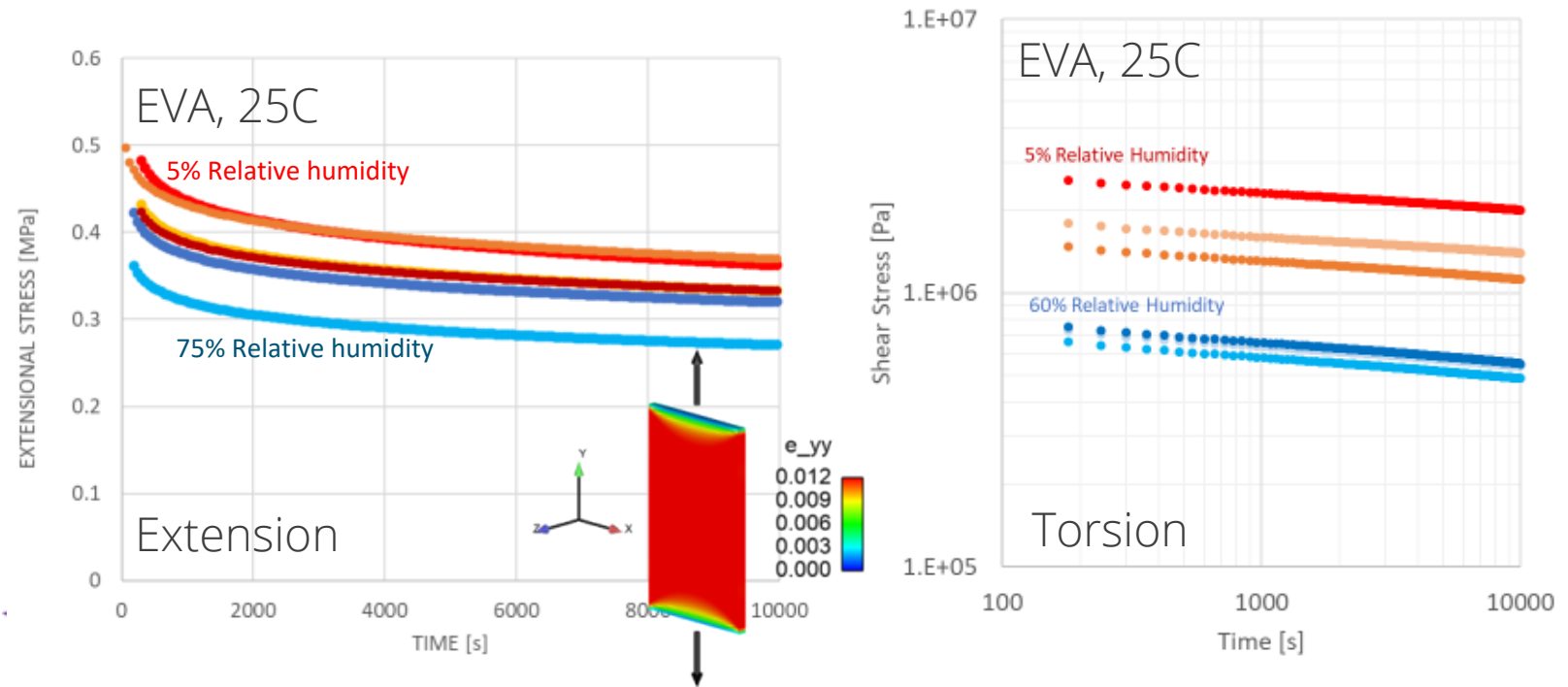
WLF shift, Generalized Maxwell model fit to each dataset  
25 terms found to give acceptable error



# CREEP AND STRESS RELAXATION IN ENCAPSULANTS



Creep is observed in modules,  
depending on operating temperature  
*Kempe et al. 2015*



Utilize stress relaxation to validate linear viscoelastic  
Maxwell constitutive model utilized by FEM

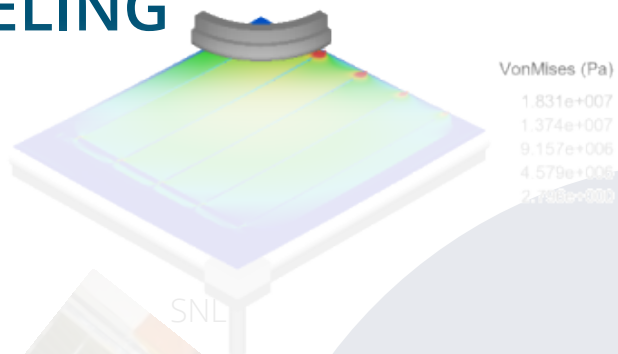
EVA is a Maxwell solid at 25 °C with a modulus  
(and relaxation time?) that depends on water content.



# ACCELERATE DESIGN CYCLES THROUGH COMPUTATIONAL MODELING



NREL

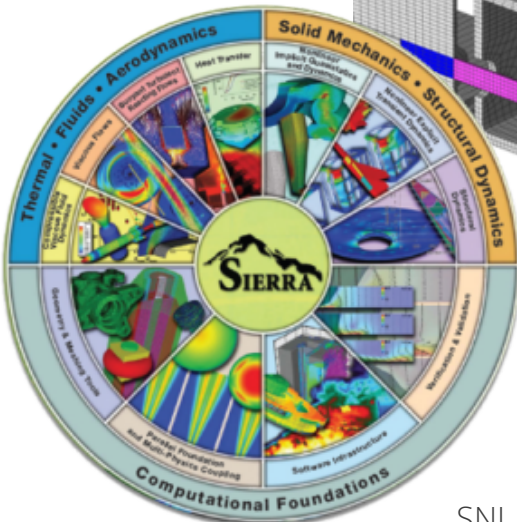
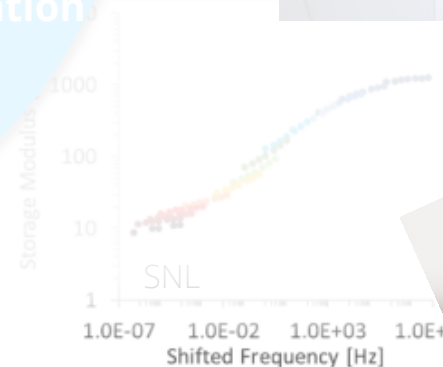
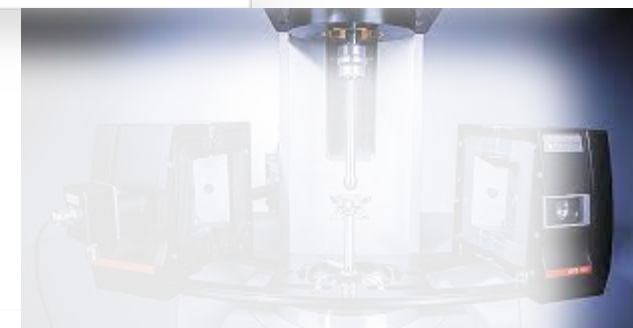
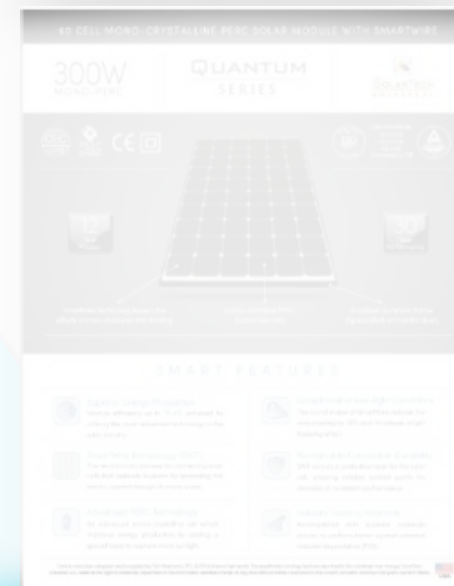


Validate

Design

Computational Model

Materials Characterization



SNL



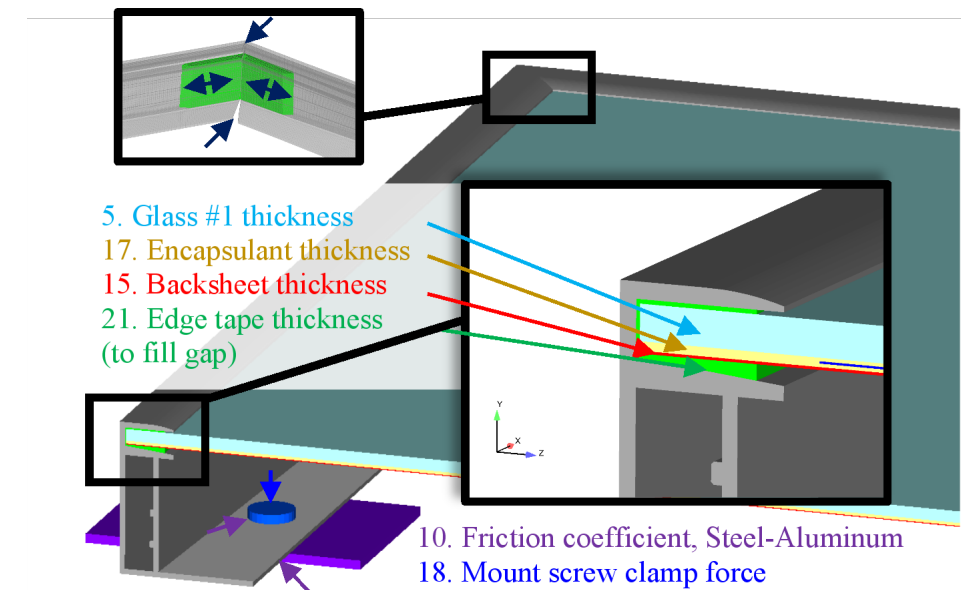
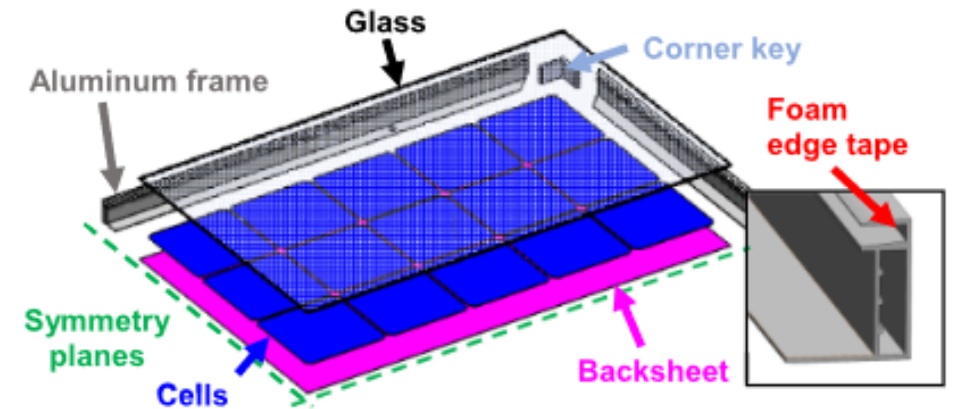
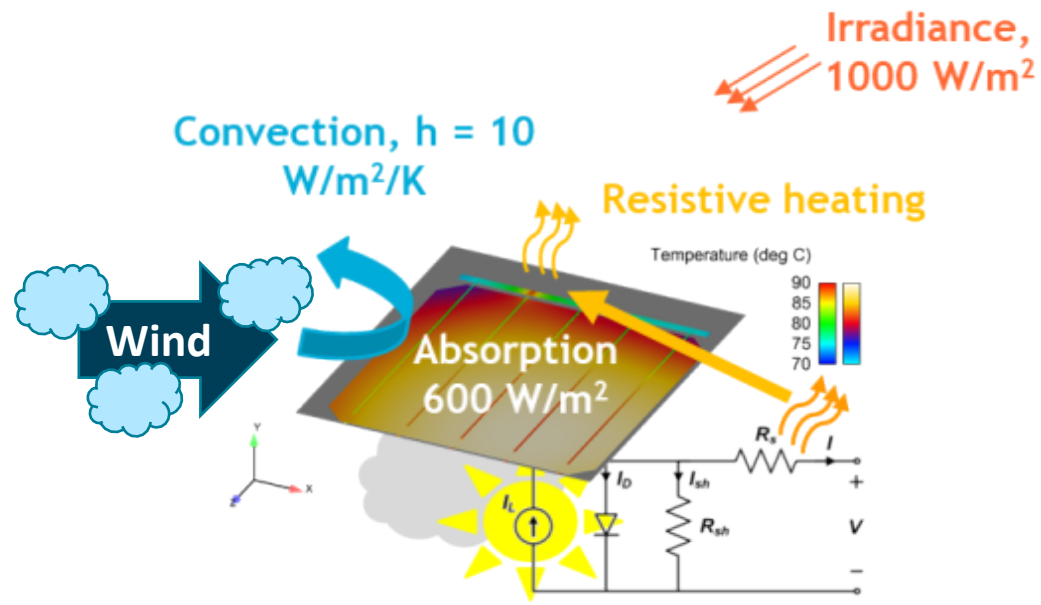
# FINITE ELEMENT MODEL CONSTRUCTION

Collaborations with module manufacturers have identified key construction details

Glass-glass and conventional silicon modules

Quarter symmetry or mini-module approaches

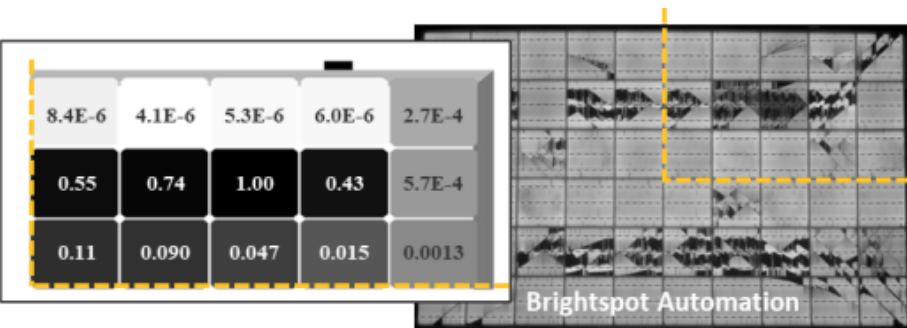
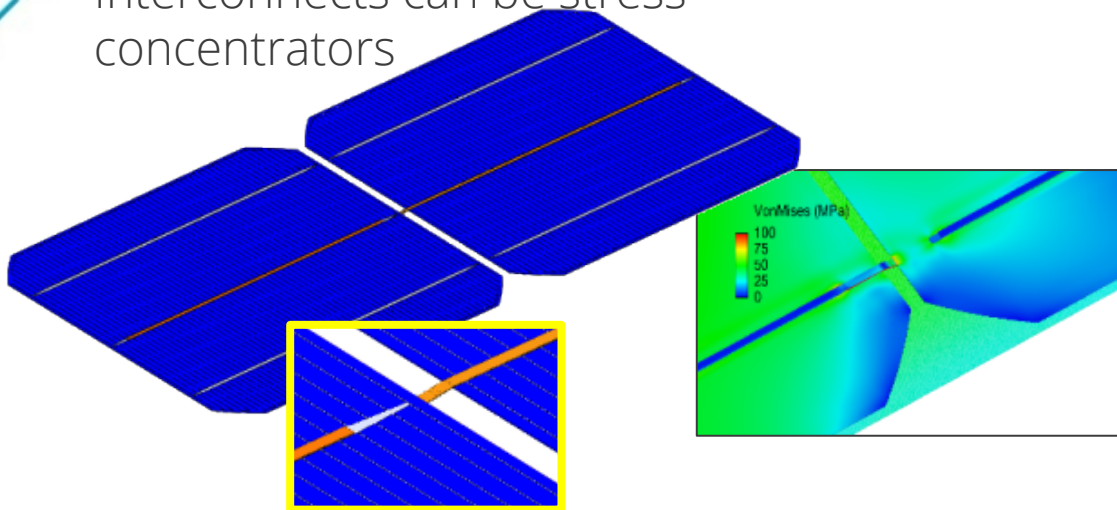
Physics: Thermal stresses, mechanical loads, thermal-electrical interactions material and design tradeoffs



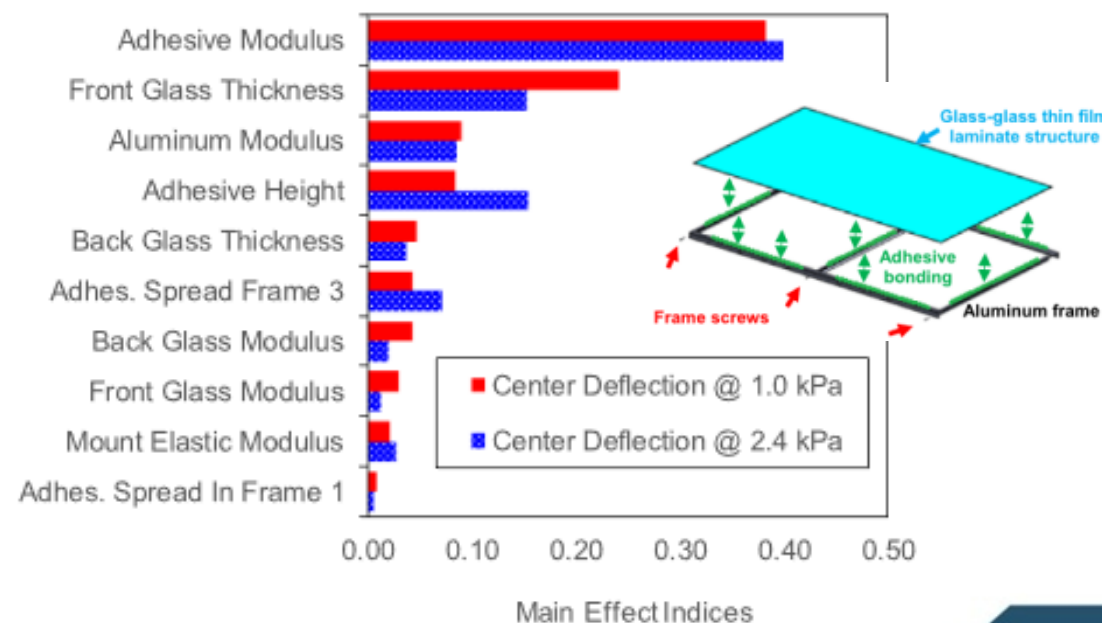
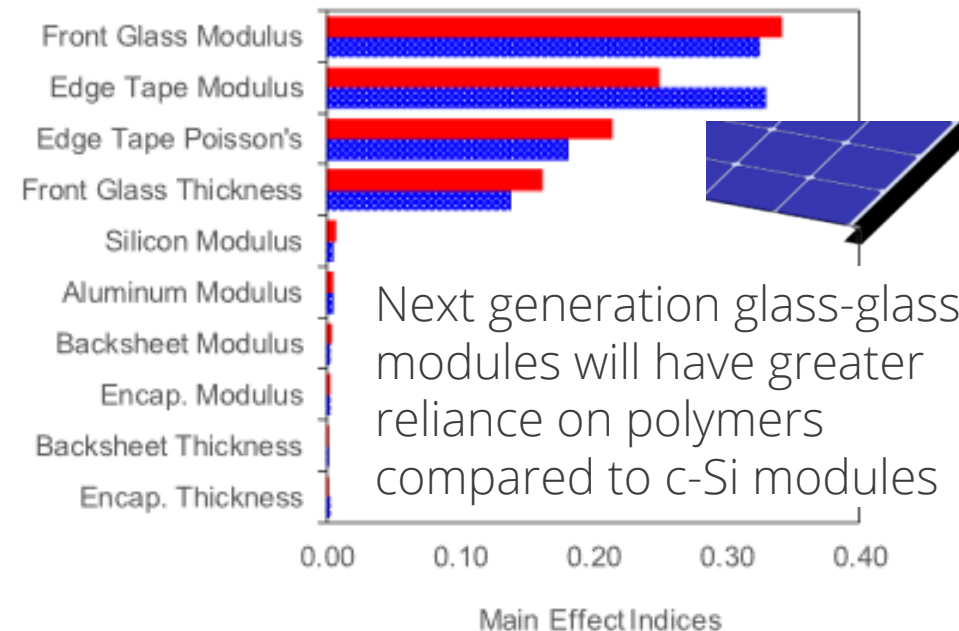


# FINITE ELEMENT MODEL RESULTS

Interconnects can be stress concentrators



Probability of cell cracking can be predicted from applied load and polymer mechanical properties

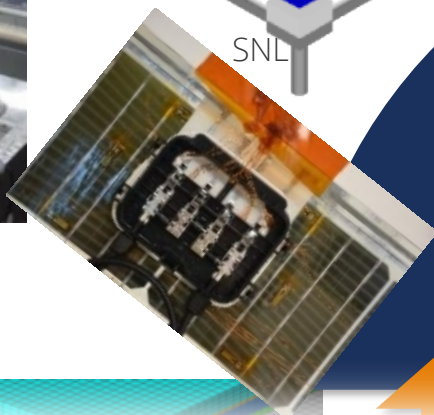
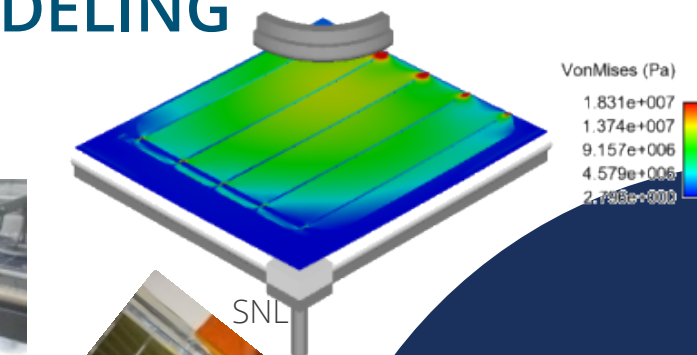




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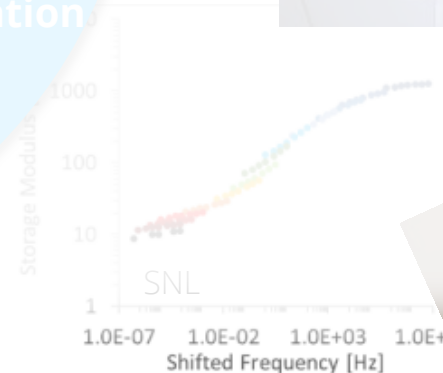
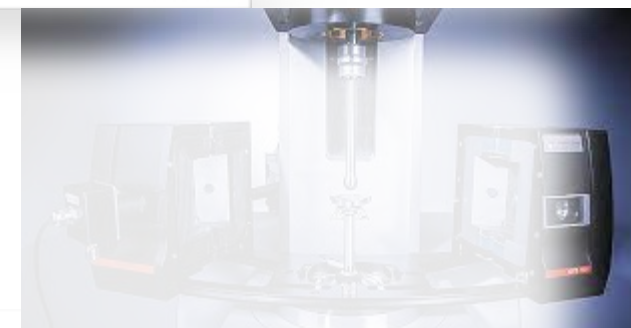
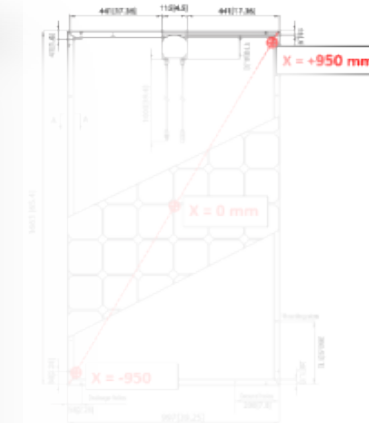


Validate

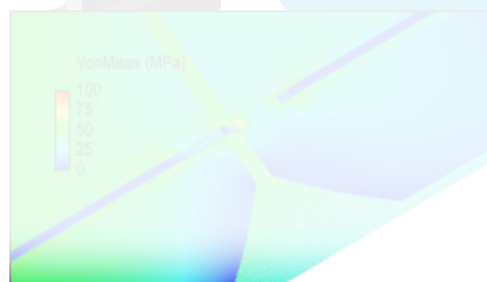
Design

Computational Model

Materials Characterization



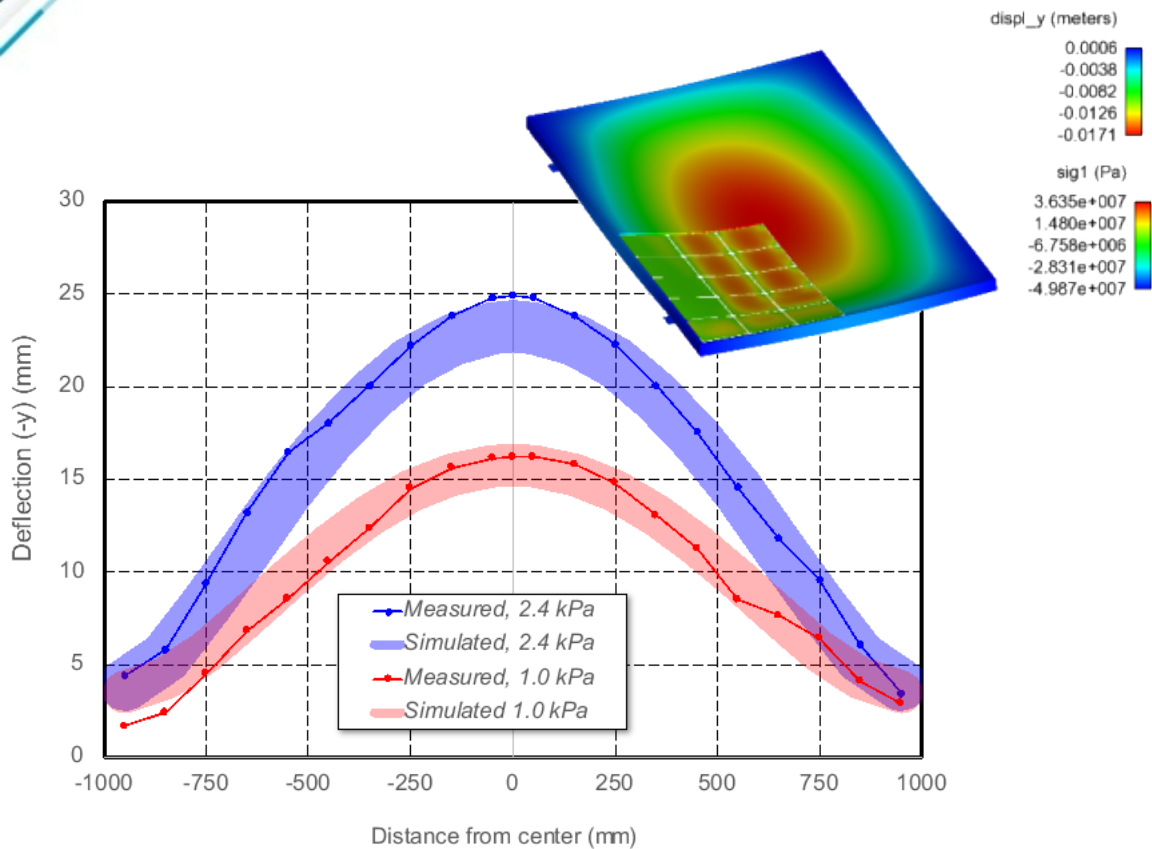
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# MODEL VALIDATION



Initial validation of FEM model  
Compare predicted deflections against full-module flexure subjected to IEC61215 pressure loads

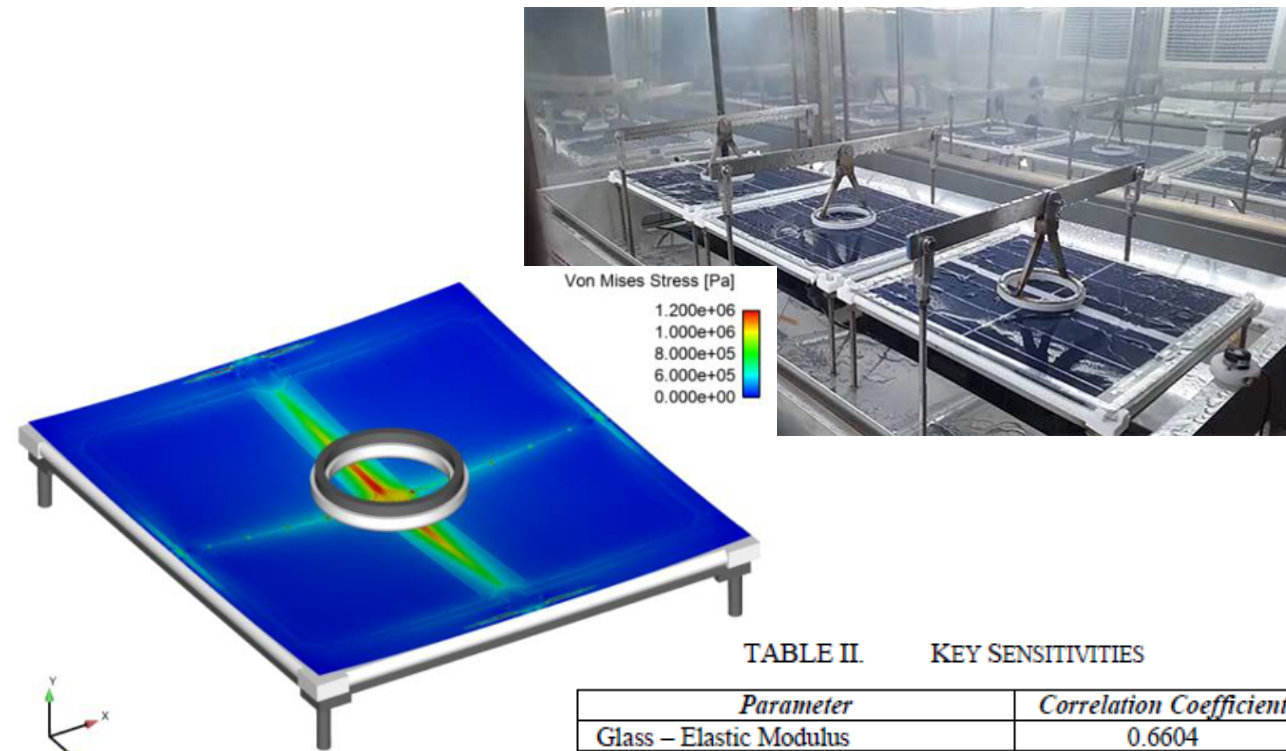
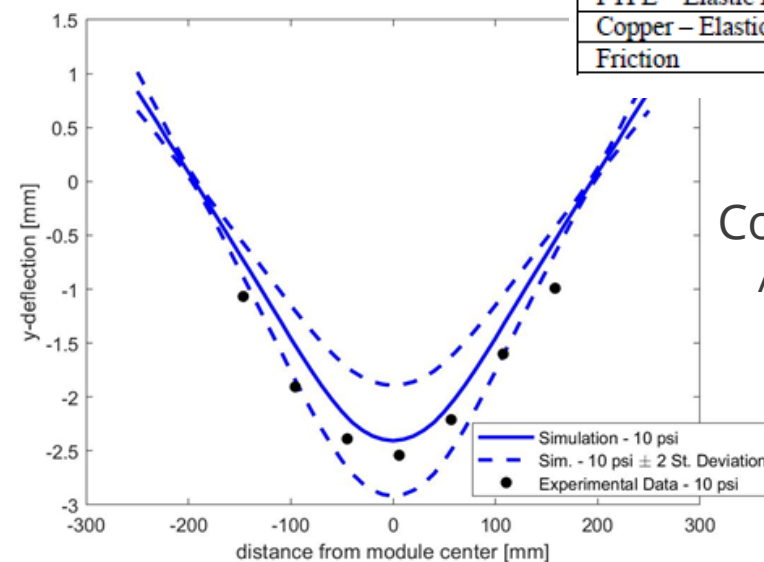


TABLE II KEY SENSITIVITIES

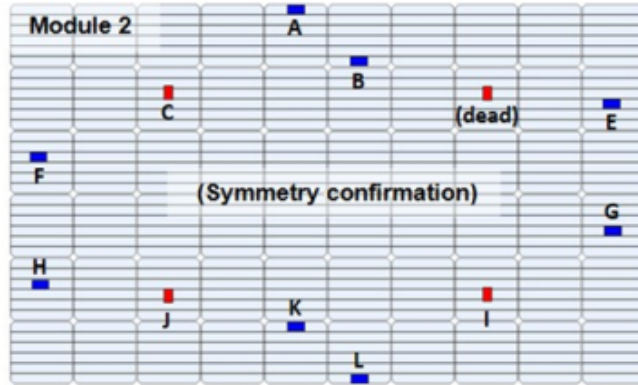
Parameter	Correlation Coefficient
Glass – Elastic Modulus	0.6604
Encapsulant – Elastic Modulus	0.3082
PTFE – Elastic Modulus	0.2004
Copper – Elastic Modulus	0.1914
Friction	0.1595



Comparison against C-AST  
Accelerated stress testing  
performed at NREL

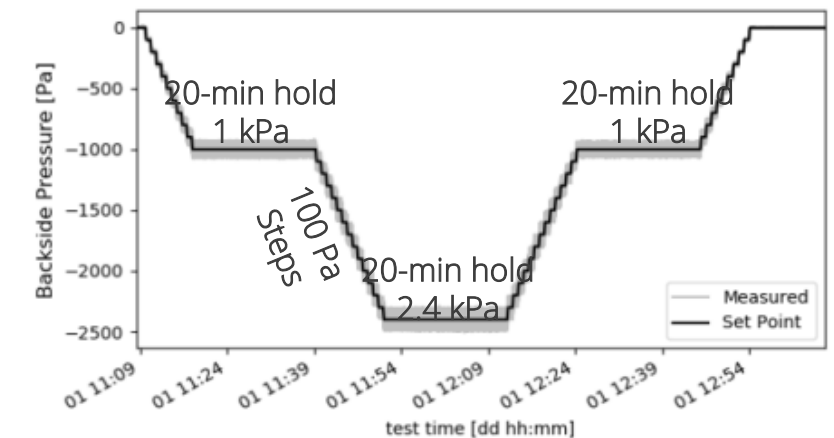
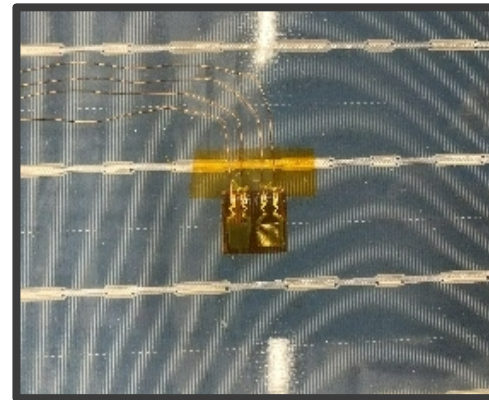
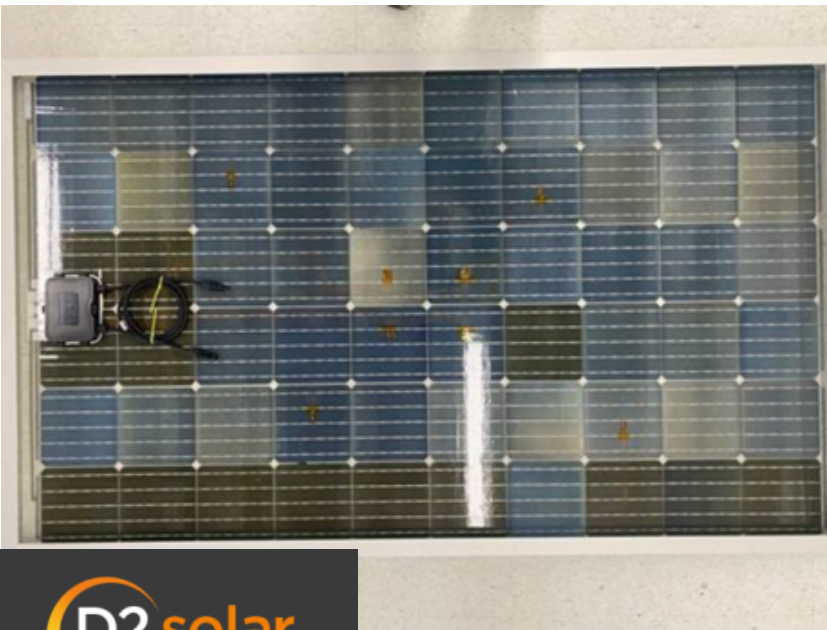
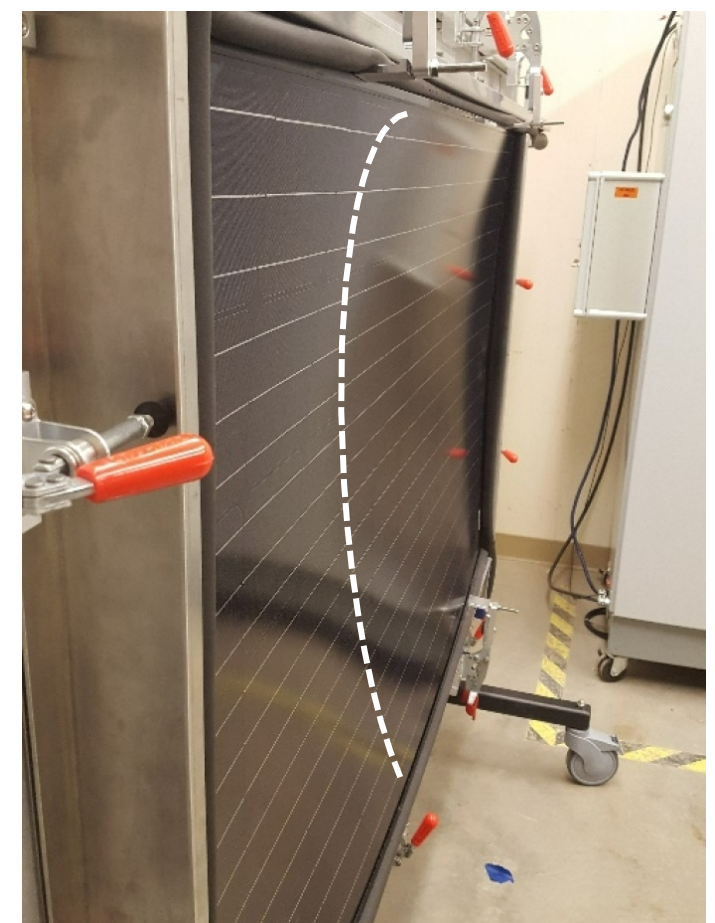


# VALIDATION: INSTRUMENTED MODULE



4 instrumented modules constructed with strain gauges to give more granularity to model comparisons.

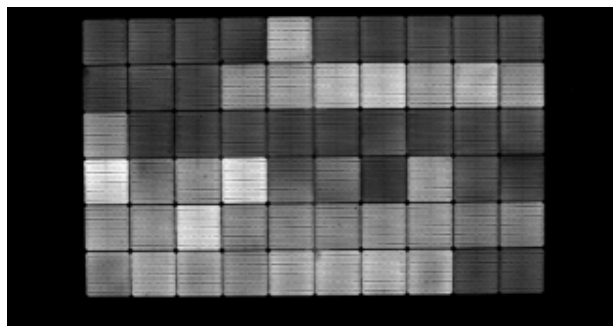
Load Spot provides deflection  
Simultaneous electroluminescence imaging



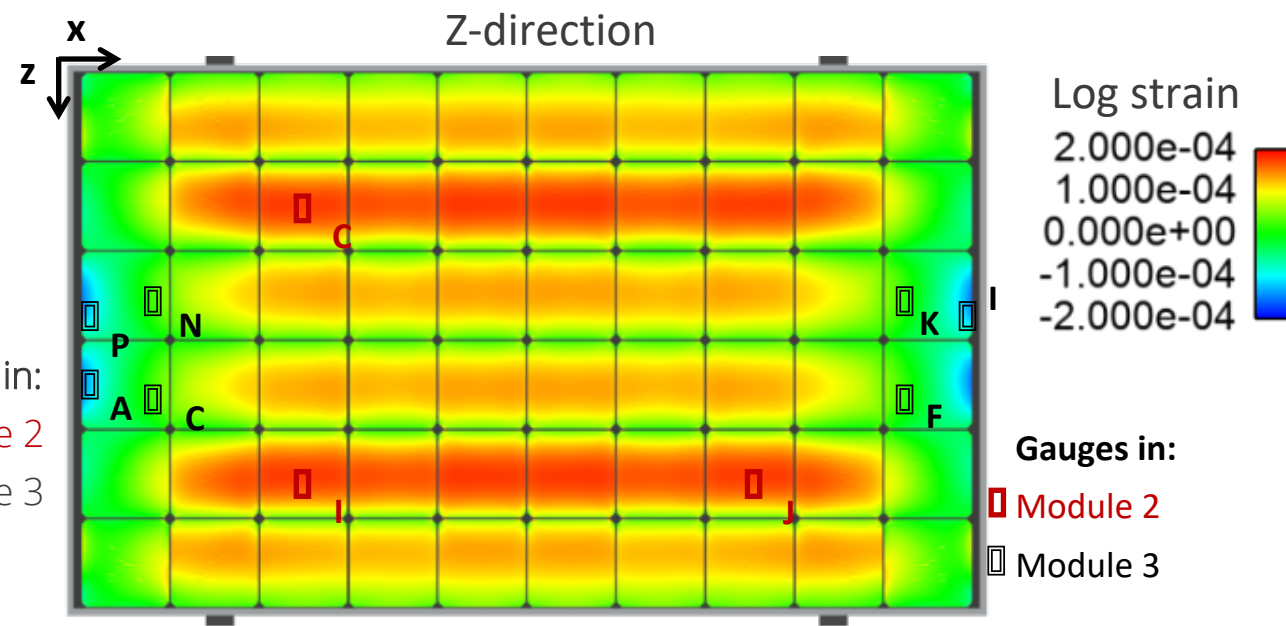
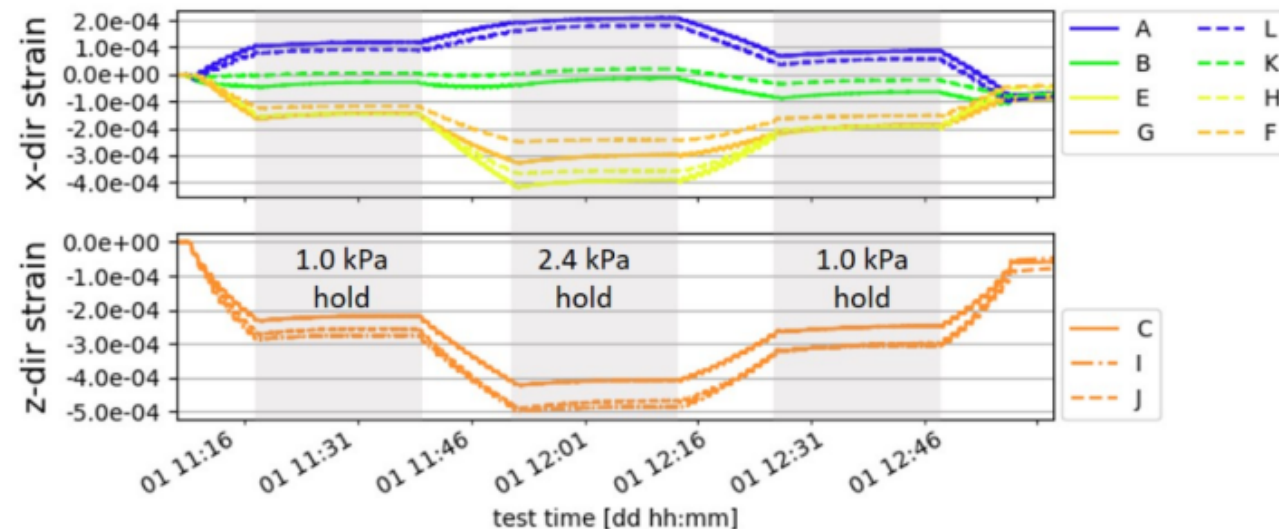
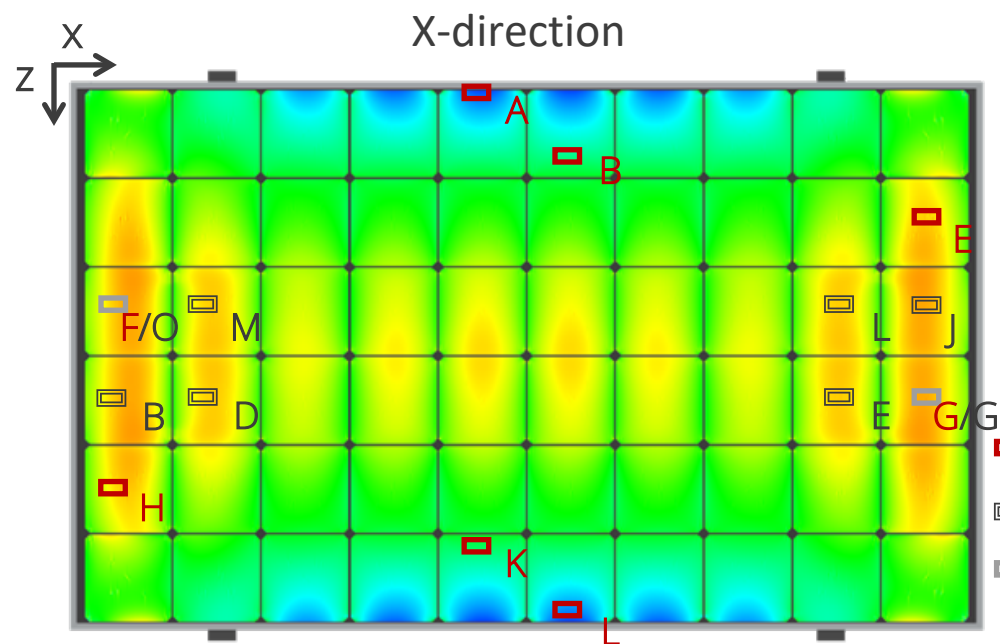




# VALIDATION RESULTS



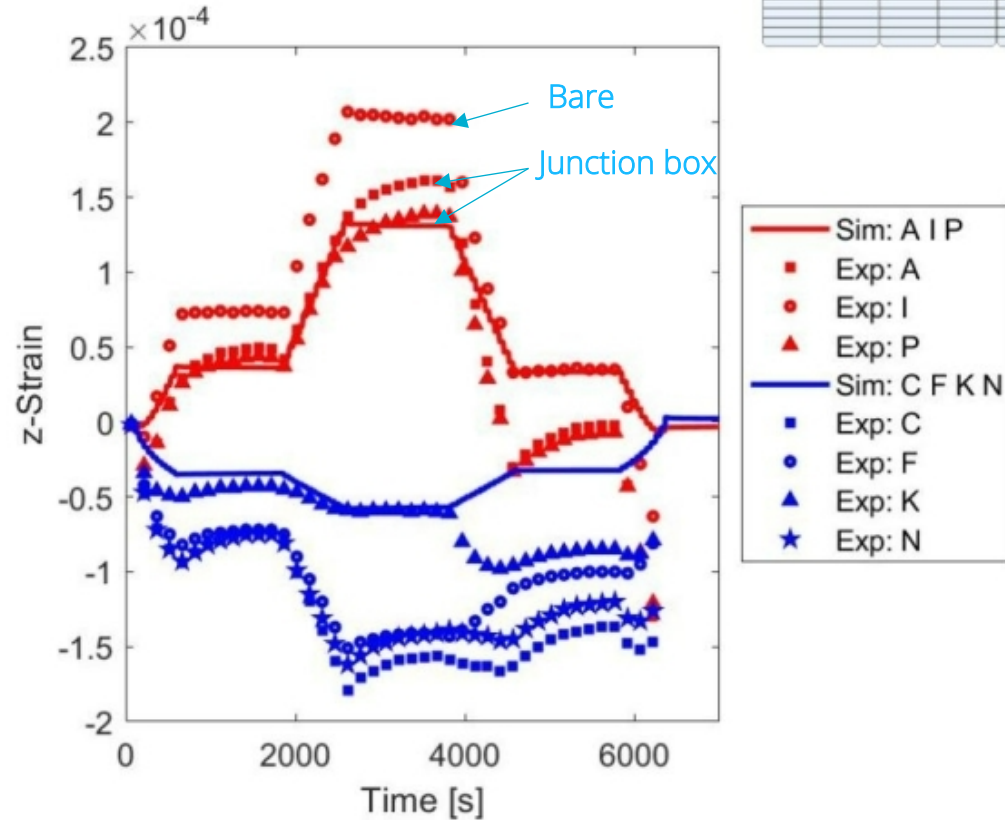
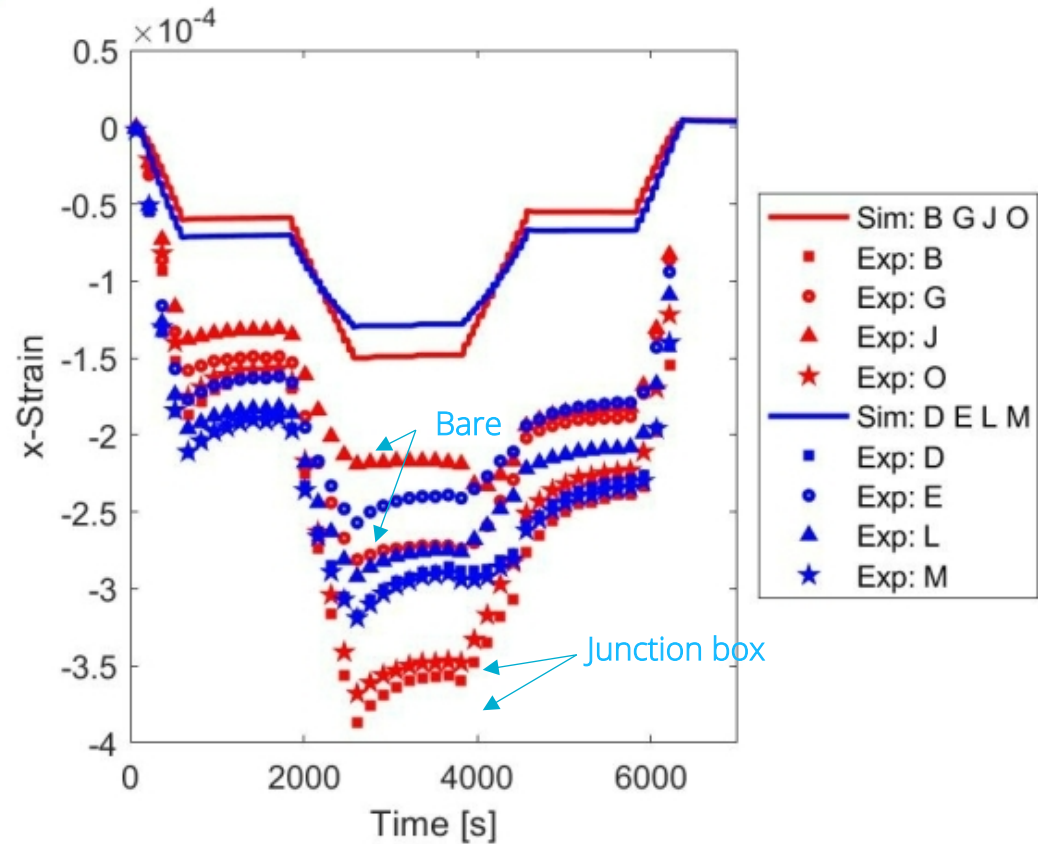
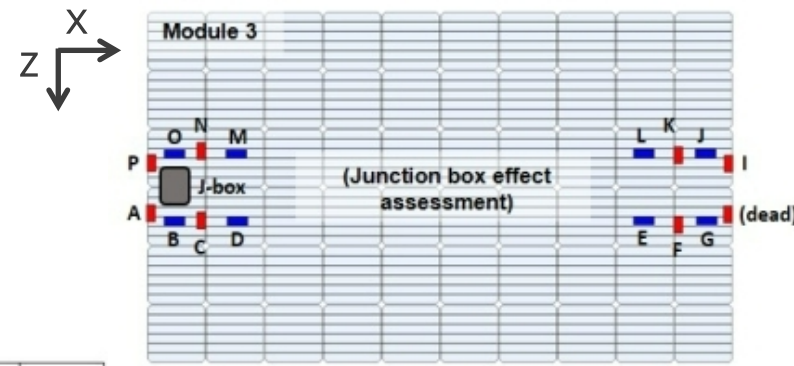
EL imaging shows modules are functional, but not optimized for electrical performance



Predicted strains (color) qualitatively match experimentally observed deformation for all strain gauge locations.



# EFFECT OF JUNCTION BOX



Junction box damps Z-strain and increases X-strain

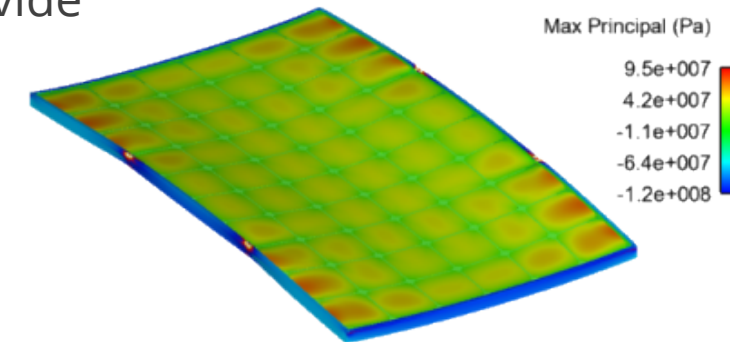
Model under-estimates stresses: Reassess FEM complexity, strain gauge placement  
Model under-represents creep: Re-evaluate mechanisms or encapsulant material model



# CONCLUSIONS



- Viscoelastic polymers provide photovoltaic module durability
  - Aging, stress relaxation, temperature all concerning to 30 year warranties
  - Aspirations for “50-year modules”
- Computational model developed through DuraMAT consortium can provide accelerated design cycles
- Plenty more to consider:
  - Modules creep over time, and manufacturing stresses relax
  - Next-generation module designs will rely more on polymer performance
  - Crystallization, crosslinking, polymer composition all could be important
  - Ruthless \$/W standards mean every design feature must perform



Funding provided as part of the Durable Module Materials Consortium (DuraMAT), an Energy Materials Network Consortium funded by the U.S. Department of Energy, Office of Energy Efficiency and Renewable Energy, Solar Energy Technologies Office.

Sandia National Laboratories is a multi-mission laboratory managed and operated by National Technology and Engineering Solutions of Sandia, LLC., a wholly owned subsidiary of Honeywell International, Inc., for the U.S. Department of Energy's National Nuclear Security Administration under contract DE-NA0003525.

Christine Roberts: [ccrober@sandia.gov](mailto:ccrober@sandia.gov)  
James Hartley: [jkyuan@sandia.gov](mailto:jkyuan@sandia.gov)